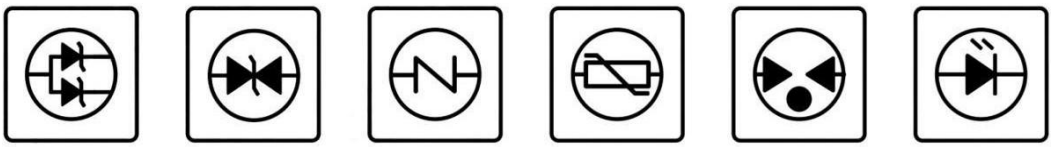
MSKSEMI 美森科
SEMICONDUCTOR



SL56-MS

Product specification

FEATURES

- Ideal for surface mount applications
- Easy pick and place
- Built-in strain relief
- Low forward voltage drop

MACHANICAL DATA

- Case: Molded plastic
- Epoxy: UL 94V-0 rate flame retardant
- Metallurgically bonded construction
- Polarity: Color band denotes cathode end
- Mounting position: Any
- Weight: 0.093 grams

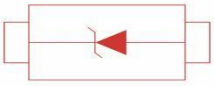
- **VOLTAGE RANGE**

  60 Volts

- **CURRENT**

  5.0 Ampere

Reference News

PACKAGE OUTLINE	PIN CONFIGURATION	Marking
 SMB		SL56

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25 C ambient temperature uniess otherwies specified.

Single phase half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

TYPE NUMBER	SL56-MS	UNITS
Maximum Recurrent Peak Reverse Voltage	60	V
Maximum RMS Voltage	42	V
Maximum DC Blocking Voltage	60	V
Maximum Average Forward Rectified Current See Fig. 1	5.0	A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	120	A
Maximum Instantaneous Forward Voltage at 2.0A	0.55	V
Maximum DC Reverse Current Ta=25 C	0.15	mA
at Rated DC Blocking Voltage Ta=125°C	30	mA
Typical Junction Capacitance (Note1)	370	pF
Typical Thermal Resistance R JA (Note 2)	70	C/W
Operating Temperature Range T_J	-55 to +125	°C
Storage Temperature Range T_{STG}	-55 to +125	°C

NOTES:

1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. P.C.B. mounted with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

RATING AND CHARACTERISTIC CURVES (SL56-MS)

FIG.1-FORWARD CURRENT DERATING CURVE

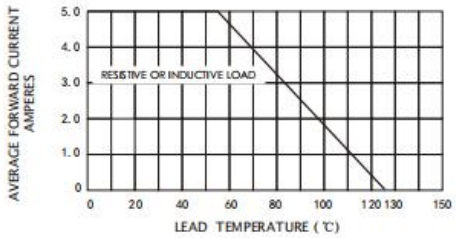


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

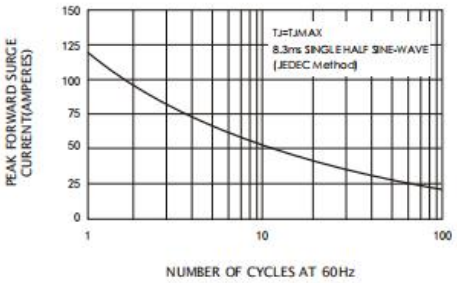


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

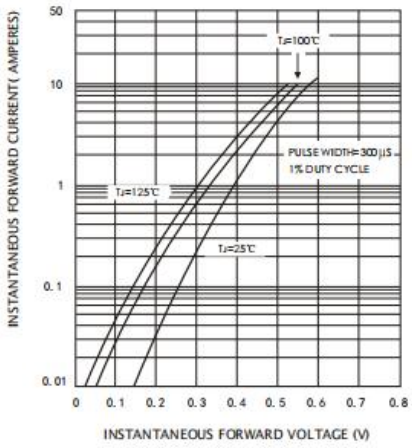


FIG.4-TYPICAL REVERSE CHARACTERISTICS

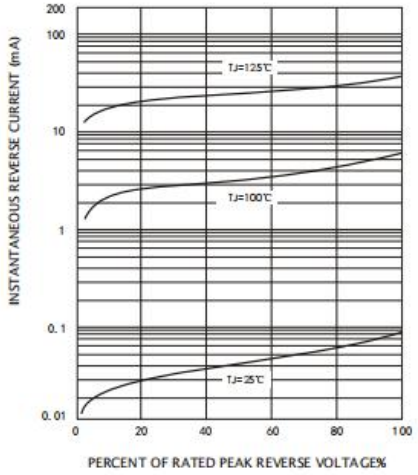
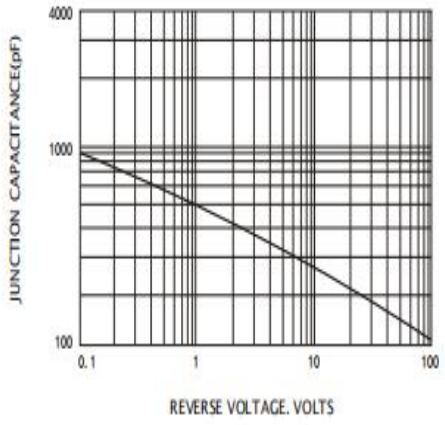
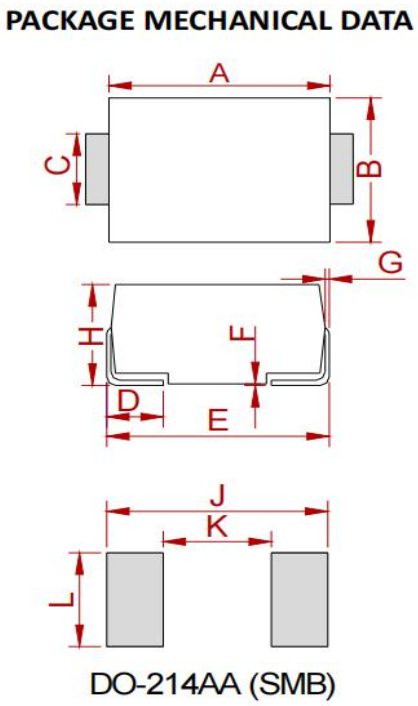


FIG.5-TYPICAL JUNCTION CAPACITANCE



PACKAGE MECHANICAL DATA



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.25	4.75	0.167	0.187
B	3.30	3.94	0.130	0.155
C	1.85	2.21	0.073	0.087
D	0.76	1.52	0.030	0.060
E	5.08	5.59	0.200	0.220
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
H	2.11	2.44	0.083	0.096
J	6.80		0.270	
K		2.60		0.100
L	2.40		0.090	

REEL SPECIFICATION

P/N	PKG	QTY
SL56-MS	SMB	3000

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